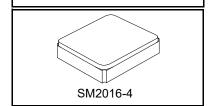


Preliminary



XTL2094H-3

40.000000 MHz Crystal Unit



Features:

- Surface Mount Hermetic Package
- Excellent Reliability Performance
- Good Frequency Perturbation and Stability over temperature
- Ultra Miniature Package
- AEC-Q200 compliance
- Moisture Sensitivity Level (MSL): Level-1

Description and Applications:

Surface mount 2.0mmx1.6mm crystal unit for use in wireless communications devices, especially for a need of ultra miniature package for mobility.

Electrical Specifications:

| XTL2094H-3 | Specification | |
|---|---|--|
| Nominal Frequency | 40.000000 MHz | |
| Mode of Oscillation | Fundamental | |
| Storage Temperature Range | -40°C to +125°C | |
| Operating Temperature Range | -40°C to +125°C | |
| Frequency Stability over -40°C to +-105°C | +/-30ppm (referred to the value at 25°C) | |
| Frequency Stability over -40°C to +125°C | +/-50 ppm (referred to the value at 25°C) | |
| Frequency Make Tolerance (FL) | +/-10 ppm @ 25°C +/- 3°C | |
| Equivalent Series Resistance (ESR) | 60 Ω max | |
| Nominal Drive Level | 50uW typical and 100uW max | |
| Shunt Capacitance (Co) | 3.0 pF max | |
| Load Capacitance (CL) | 10 pF | |
| Aging | +/-2ppm/year | |
| Insulation Resistance | 500 MΩ min./DC 100V | |
| Marking | Laser Marking | |

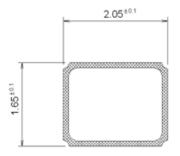
| Unit Weight | 5.7mg+/-0.5mg |
|---|---|
| Specification(Crystal curve fitting) | |
| Inflection Temperature | +27.2°C +/- 2°C |
| First-order Curve Fitting Parameter (C1) | -0.47 ppm/°C typical |
| Second-order Curve Fitting Parameter (C2) | -0.57 x10 ⁻⁴ ppm/°C ² typical |
| Third-order Curve Fitting Parameter (C3) | +10.02 x10 ⁻⁵ ppm/°C³ typical |

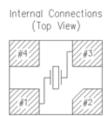


CAUTION: Electrostatic Sensitive Device. Observe precautions for handling. **NOTES:**

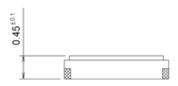
- 1. The design, manufacturing process, and specifications of this device are subject to change.
- 2. US or International patents may apply.
- 3. This component was always RoHS compliant from the first date of manufacture.

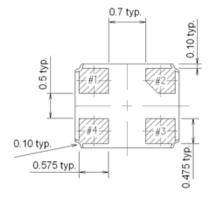
Mechanical Dimensions (mm): Base





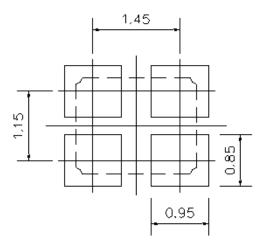
[NOTE] #2, #4 is connected with a cover





| | Pin Connection |
|--------|----------------|
| #1 pin | IN/OUT |
| #2 pin | GND |
| #3 pin | IN/OUT |
| #4 pin | GND |

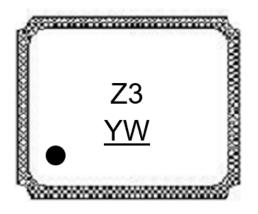
Recommended Land Pattern: (unit: mm)

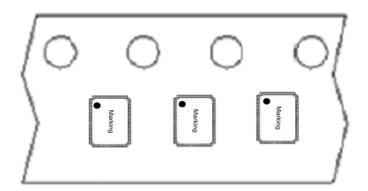


Recommended Land Pattren

Marking:

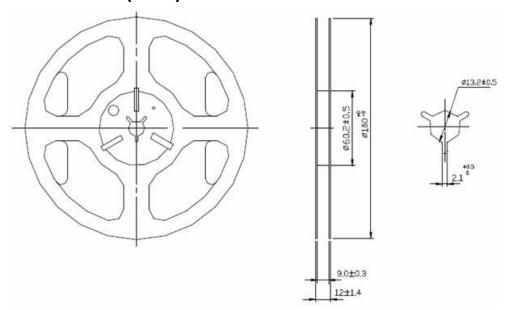
Line 1: Symbol Code Line 2: Y = Year, W = week



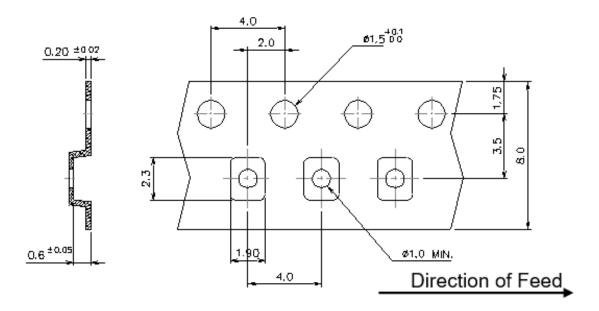


Reel Dimensions (mm):

Reel Count: 7" = 3000



Tape Dimensions (mm):

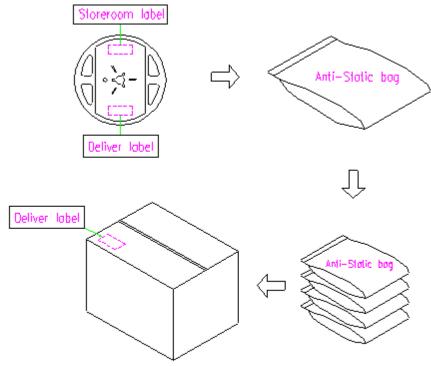


[NOTE]:

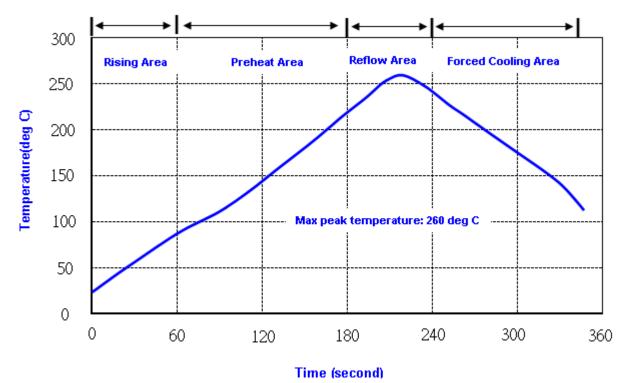
- 1. Unless otherwise specified tolerance on dimension +/-0.1 mm.
- 2. Material: conductive polystyrene with color black.
- 3. 10 pitch cumulative tolerance +/-0.2 mm.

Packing Quantity/Packing:

3K pcs maximum per reel



Reflow Profile:



Note: 1.Max peak temperature: 260+/-5 deg C; Time: 10+/-2 sec

2. Temperature: 217+/-5 deg C; Time: 90~100 sec

Reliability Specifications (AEC-Q200)

| Test name | Test process / method | Reference standard | | | |
|---------------------------------------|---|-------------------------------|--|--|--|
| Mechanical cha | Mechanical characteristics | | | | |
| resistance to Soldering heat | Temp./ Duration : 265°C /10sec ×2 times Total time : 4min.(IR-reflow) | EIAJED-4701 | | | |
| (IR reflow) | | -300(301)M(II) | | | |
| Vibration | Total peak amplitude : 1.5mm Vibration frequency : 10 to 2000 Hz Sweep period : 20 minute Vibration directions : 3 mutually perpendicular | MIL-STD 202G method 204 | | | |
| Mechanical Shock | directions : 3 impacts per axis Acceleration : 6000g's, +20/-0 % Duration : 0.3 ms (total 18 shocks) Waveform : Half-sine | MIL-STD 202G method 213 | | | |
| Solderability | Solder Temperature:265±5°C Duration time: 5±0.5 seconds. | J-STD-002 | | | |
| Environmental characteristics | | | | | |
| Thermal Shock | Heat cycle conditions -55 °C (30min) ←→ 125 °C (30min) * cycle time : 1000 times | MIL-STD 883G method 1010.8 | | | |
| Humidity test | Temperature : 85 ± 2 °C Relative humidity : 85% Duration : 1000 hours | MIL-STD 202G method 103 | | | |
| Dry heat (Aging test) | Temperature : 125 ± 2 °C Duration : 1000 hours | MIL-STD 202G method 108A | | | |
| Cold resistance (Low Temp Storage) | Temperature : -40 ± 3 °C Duration : 1000 hours | IEC 60068-2-1 | | | |